

Material Content Data Sheet

RoHS

Sales Product Name	SPU02N60C3	**Issued**	09. February 2022
MA#	MA005618178		
Package	PG-TO251-3-341	**Weight***	381.14 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.473	0.39	0.39	3864	3864
leadframe	inorganic material	phosphorus	7723-14-0	0.075	0.02		196	
	non noble metal	iron	7439-89-6	0.248	0.07		652	
	non noble metal	copper	7440-50-8	248.124	65.10	65.19	651006	651854
wire	non noble metal	aluminium	7429-90-5	0.510	0.13	0.13	1337	1337
encapsulation	inorganic material	antimonytrioxide	1309-64-4	1.745	0.46		4579	
	plastics	brominated resin	-	1.870	0.49		4906	
	organic material	carbon black	1333-86-4	1.995	0.52		5233	
	plastics	epoxy resin	-	16.830	4.42		44157	
	inorganic material	silicondioxide	60676-86-0	102.226	26.82	32.71	268212	327087
leadfinish	non noble metal	tin	7440-31-5	3.740	0.98	0.98	9813	9813
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1335	1335
solder	non noble metal	tin	7440-31-5	0.036	0.01		94	
	noble metal	silver	7440-22-4	0.045	0.01		118	
	non noble metal	lead	7439-92-1	1.714	0.45	0.47	4498	4710
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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